

LEXANT™ VISUALFX™ RESIN FXD171R

REGION AMERICAS

DESCRIPTION

Transparent/translucent PC for light diffusion special effects. MFR of 25.0.

TYPICAL PROPERTY VALUES

Revision 20241028

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yld, Type I, 50 mm/min	62	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	64	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	6.2	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	125	%	ASTM D638
Tensile Modulus, 50 mm/min	2330	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	93	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2340	MPa	ASTM D790
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	779	J/m	ASTM D256
Instrumented Dart Impact Total Energy, 23°C	70	J	ASTM D3763
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 3.2 mm, unannealed	137	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	126	°C	ASTM D648
Relative Temp Index, Elec ⁽²⁾	130	°C	UL 746B
Relative Temp Index, Mech w/impact ⁽²⁾	130	°C	UL 746B
Relative Temp Index, Mech w/o impact ⁽²⁾	130	°C	UL 746B
PHYSICAL ⁽¹⁾			
Specific Gravity	1.19	-	ASTM D792
Mold Shrinkage, flow, 3.2 mm ⁽³⁾	0.5 – 0.7	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	25	g/10 min	ASTM D1238
ELECTRICAL ⁽¹⁾			
Comparative Tracking Index (UL) {PLC}	2	PLC Code	UL 746A
Hot-Wire Ignition (HWI), PLC 2	≥1.5	mm	UL 746A
Hot-Wire Ignition (HWI), PLC 3	≥1.1	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 0	≥1.5	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 1	≥3	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 2	≥1.1	mm	UL 746A
High Voltage Arc Track Rate {PLC}	2	PLC Code	UL 746A
FLAME CHARACTERISTICS ⁽²⁾			
UL Yellow Card Link	E121562-220945	-	-
UL Recognized, 94V-2 Flame Class Rating	≥1.1	mm	UL 94
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	

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Drying Time (Cumulative)	48	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	270 – 295	°C	
Nozzle Temperature	265 – 290	°C	
Front - Zone 3 Temperature	270 – 295	°C	
Middle - Zone 2 Temperature	260 – 280	°C	
Rear - Zone 1 Temperature	250 – 270	°C	
Mold Temperature	70 – 120	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	40 – 70	rpm	
Shot to Cylinder Size	40 – 60	%	
Vent Depth	0.025 – 0.076	mm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article. The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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